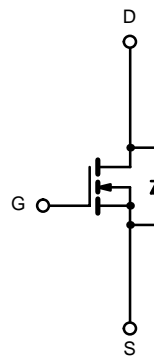
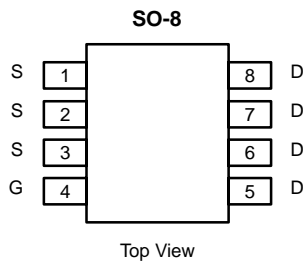




N-Channel 150-V (D-S) MOSFET

PRODUCT SUMMARY		
V_{DS} (V)	$r_{DS(on)}$ (Ω)	I_D (A)
150	0.085 @ $V_{GS} = 10$ V	3.7
	0.095 @ $V_{GS} = 6.0$ V	3.5

TrenchFET[®]
Power MOSFETs



ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)				
Parameter	Symbol	10 secs	Steady State	Unit
Drain-Source Voltage	V_{DS}	150		V
Gate-Source Voltage	V_{GS}	± 20		
Continuous Drain Current ($T_J = 150^\circ\text{C}$) ^a	I_D	$T_A = 25^\circ\text{C}$	3.7	2.7
		$T_A = 70^\circ\text{C}$	3.0	2.1
Pulsed Drain Current	I_{DM}	25		A
Avalanch Current	I_{AS}	10		
Continuous Source Current (Diode Conduction) ^a		I_S	2.5	
Maximum Power Dissipation ^a	P_D	$T_A = 25^\circ\text{C}$	3.0	1.5
		$T_A = 70^\circ\text{C}$	1.9	1.0
Operating Junction and Storage Temperature Range	T_J, T_{stg}	-55 to 150		$^\circ\text{C}$

THERMAL RESISTANCE RATINGS				
Parameter	Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient ^a	R_{thJA}	$t \leq 10$ sec	35	42
		Steady State	68	82
Maximum Junction-to-Foot (Drain)	R_{thJF}	18	23	$^\circ\text{C/W}$

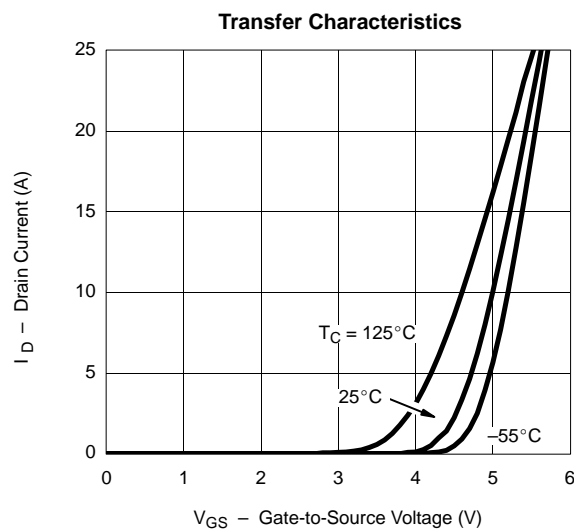
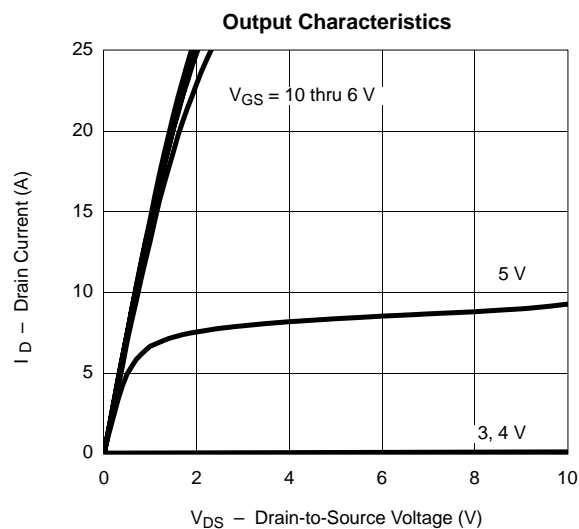
Notes
a. Surface Mounted on 1" x 1" FR4 Board.

SPECIFICATIONS (T_J = 25 °C UNLESS OTHERWISE NOTED)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Static						
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250 μA	2.0			V
Gate-Body Leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = ±20 V			±100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 120 V, V _{GS} = 0 V			1	μA
		V _{DS} = 120 V, V _{GS} = 0 V, T _J = 55 °C			5	
On-State Drain Current ^a	I _{D(on)}	V _{DS} ≥ 5 V, V _{GS} = 10 V	25			A
Drain-Source On-State Resistance ^a	r _{DS(on)}	V _{GS} = 10 V, I _D = 3.5 A		0.068	0.085	Ω
		V _{GS} = 6.0 V, I _D = 3.0 A		0.076	0.095	
Forward Transconductance ^a	g _{fs}	V _{DS} = 15 V, I _D = 5 A		15		S
Diode Forward Voltage ^a	V _{SD}	I _S = 2.5 A, V _{GS} = 0 V		0.75	1.2	V
Dynamic^b						
Total Gate Charge	Q _g	V _{DS} = 75 V, V _{GS} = 10 V, I _D = 3.5 A		17	21	nC
Gate-Source Charge	Q _{gs}			3.2		
Gate-Drain Charge	Q _{gd}			6.0		
Turn-On Delay Time	t _{d(on)}	V _{DD} = 75 V, R _L = 21 Ω I _D = 3.5 A, V _{GEN} = 10 V, R _G = 6 Ω		9.0	14	ns
Rise Time	t _r			10	15	
Turn-Off Delay Time	t _{d(off)}			24	35	
Fall Time	t _f			17	25	
Gate Resistance	R _g				0.85	
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 2.5 A, di/dt = 100 A/μs		45	70	ns

Notes

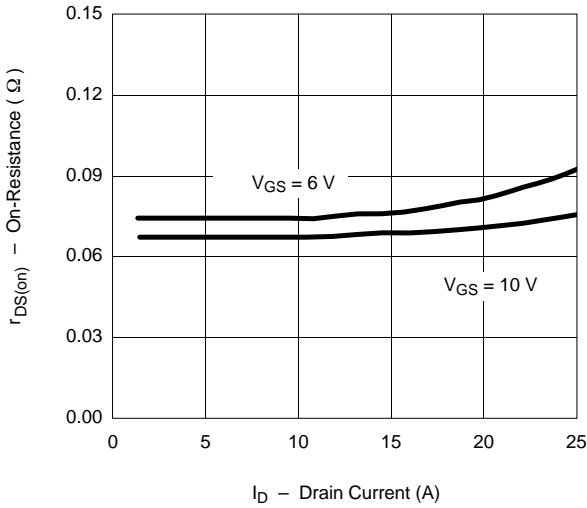
- a. Pulse test; pulse width ≤ 300 μs, duty cycle ≤ 2%.
b. Guaranteed by design, not subject to production testing.

TYPICAL CHARACTERISTICS (25 °C UNLESS NOTED)

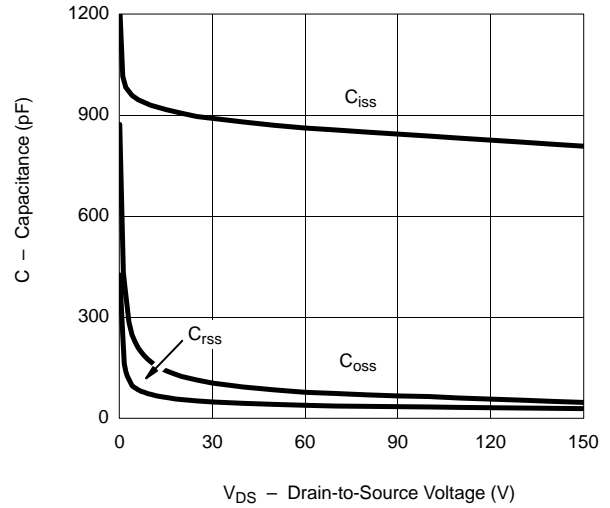


TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)

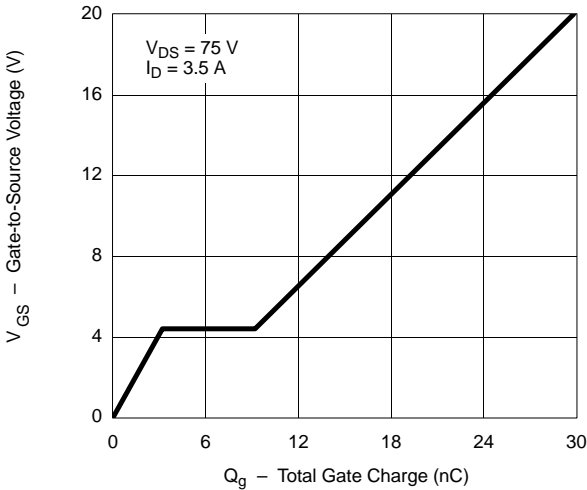
On-Resistance vs. Drain Current



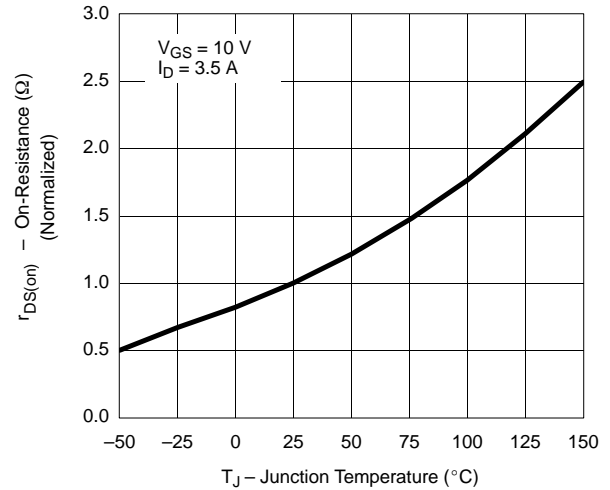
Capacitance



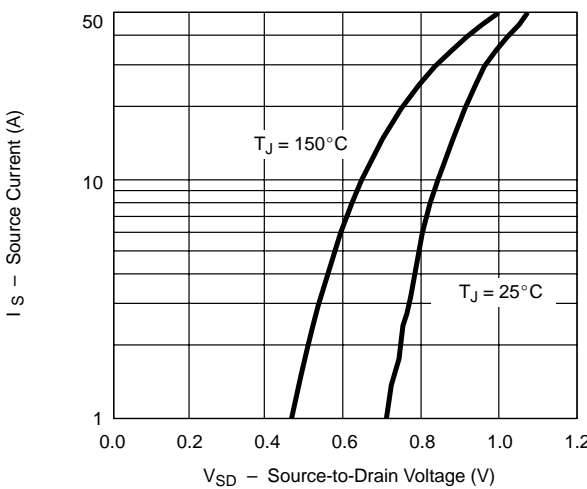
Gate Charge



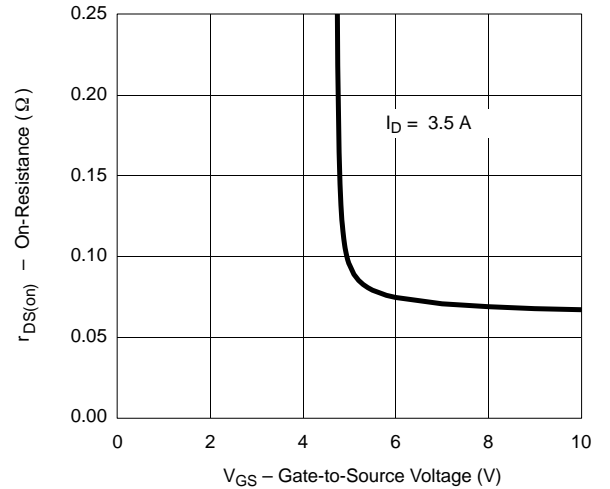
On-Resistance vs. Junction Temperature



Source-Drain Diode Forward Voltage



On-Resistance vs. Gate-to-Source Voltage



TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)

